

# RL78 Family

## DLMS Physical Layer User Manual

REJxxxxxxx-0100

Rev.1.00

December 12, 2013

### Introduction

This document explains the usage of DLMS physical layer.

### Target Device

Energy Meter based on RL78 Family Device.

### Contents

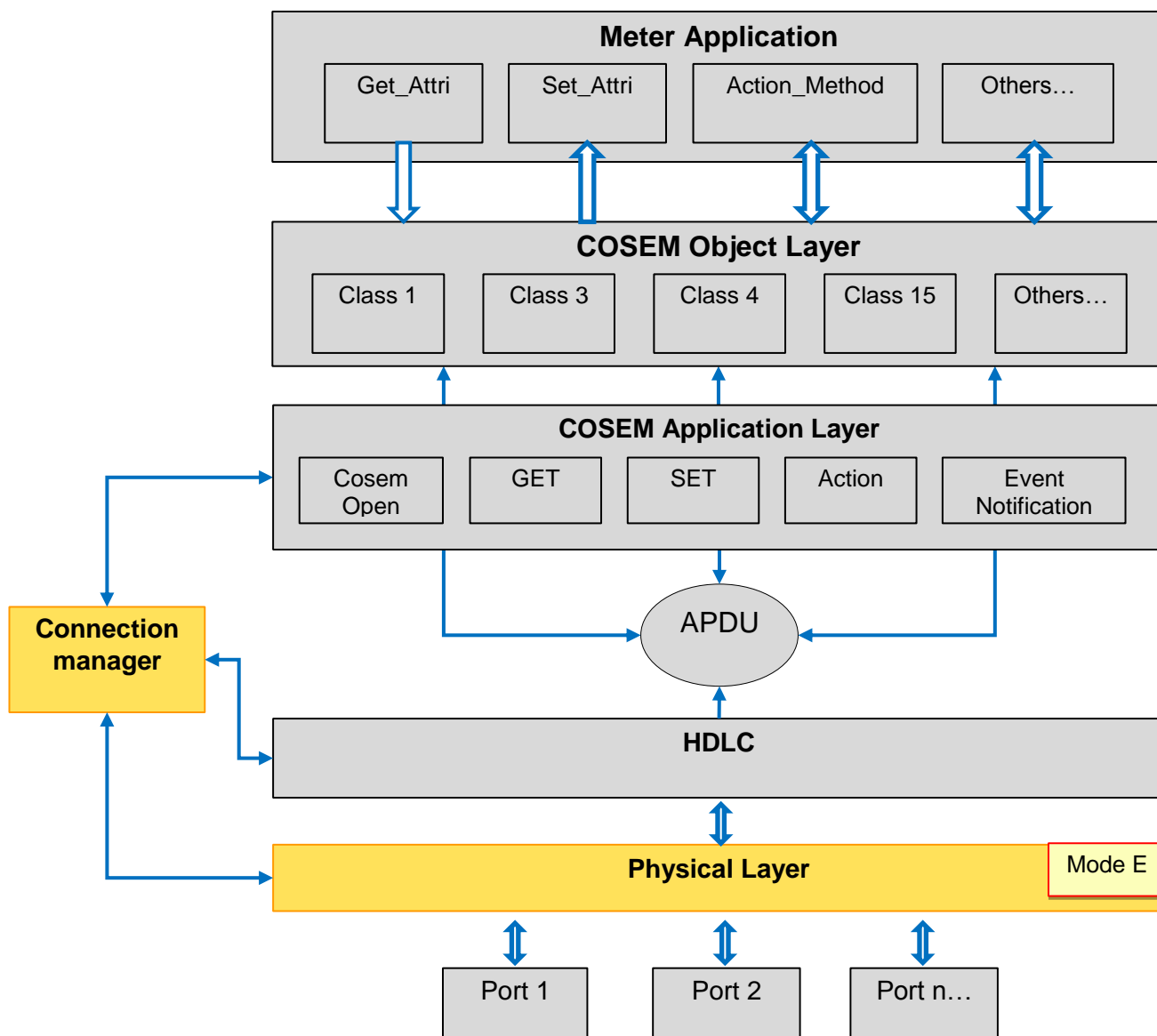
1. Overview.....	2
2. Files/directories composition .....	3
3. Basic operation .....	6
4. Detail Implementation.....	8
5. Sample workspace .....	21

### REFERENCES

- Green\_Book\_7th\_edition.pdf

# 1. Overview

The software composition below shows DLMS physical layer in relationship with other layers:



**Figure 1 Software composition**

The implementation for DLMS physical layer includes 2 parts:

- Connection manager: interface layer with others layer to manage all channels/ ports.
- Physical Layer: implementation for hardware accessing and mode E.

## 2. Files/directories composition

The detail of DLMS physical layer file structure is described as below:

- Connection manager: implemented as connmgr folder.
- Physical Layer: consists of
  - Physical service implemented as physcalservice folder.
  - User-defined Physical Layer implemented as physical folder.

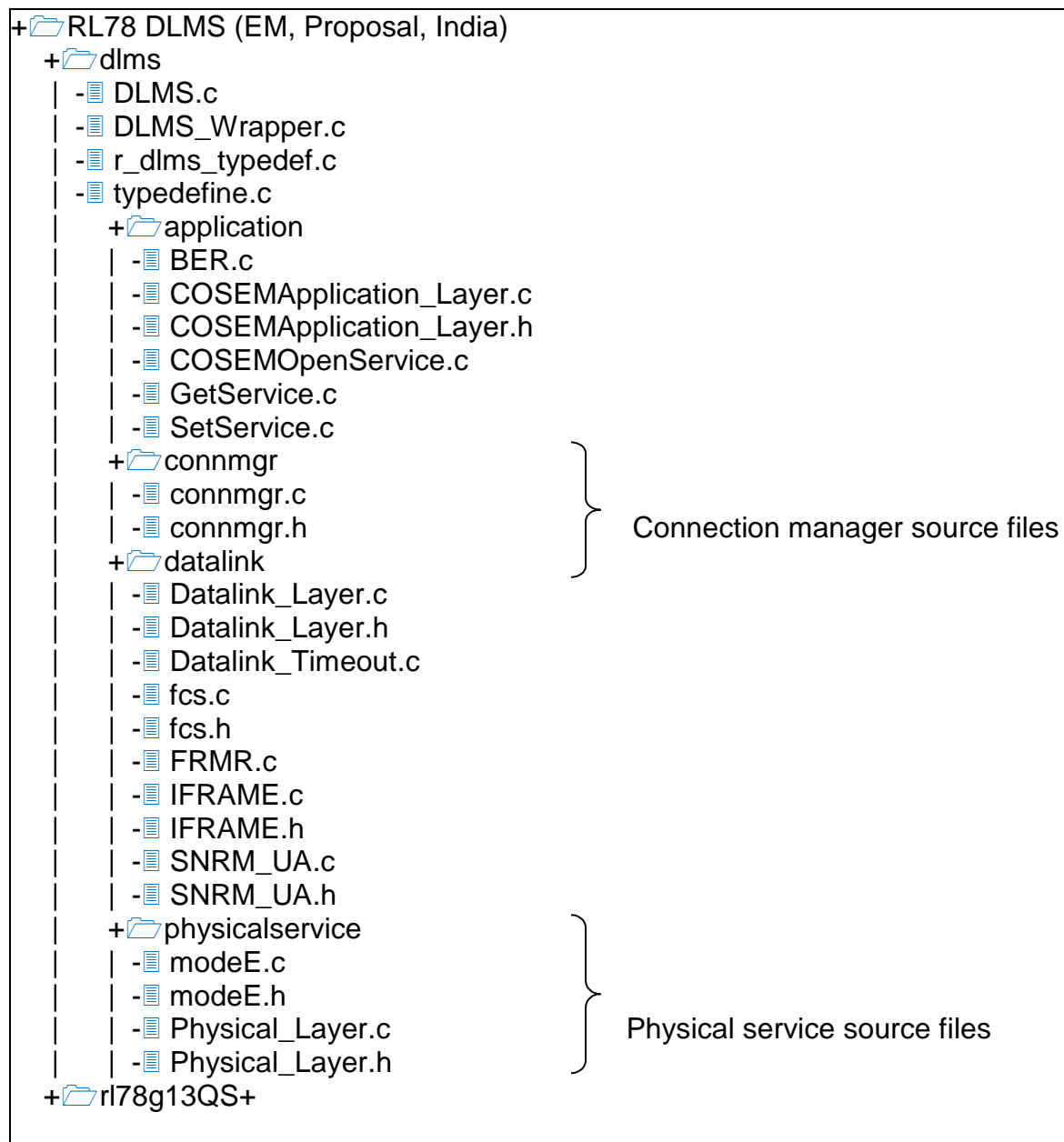


Figure 2 File structure of DLMS physical layer

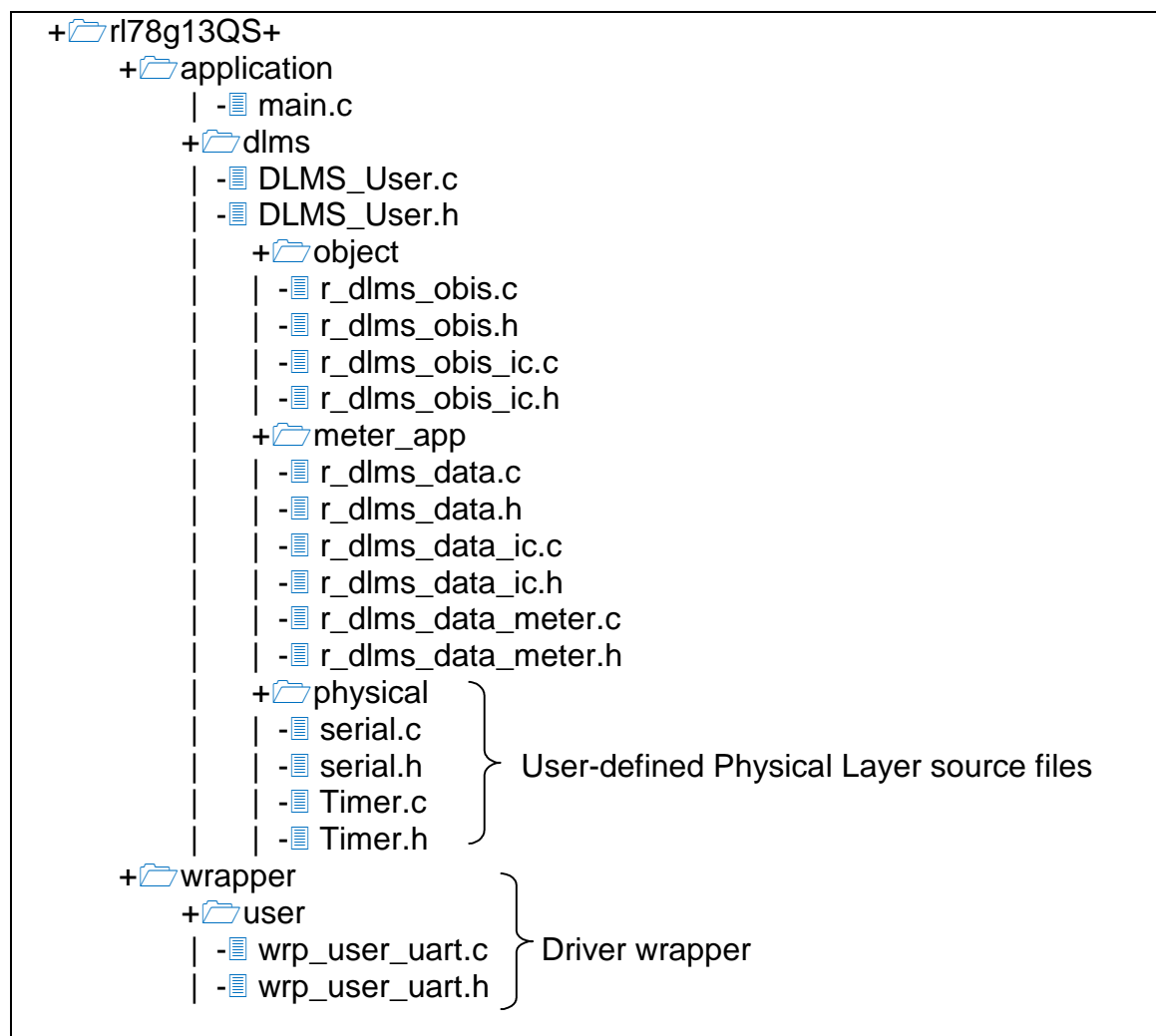


Figure 3 File structure of DLMS physical layer

Table 1 File structure explanation

No.	File name	Description
1	connmgr.c	Connection manager source file. Implement for all connection manager APIs.
2	connmgr.h	Connection manager header file. Declare all related structure definition for connection manager.
3	mode_E.c	Mode E source file. Implementation for mode E protocol.
4	mode_E.h	Mode E header file. Declare all related structure definition for mode E.
5	Physical_Layer.c	Physical layer source file. Implement for all Physical layer service APIs.
6	Physical_Layer.h	Physical layer header file. Declare all related structure definition for Physical layer.
7	serial.c	Serial source file. Implemented by user/ customer to access the driver wrapper.
8	serial.h	Serial definition header file.
9	Timer.c	Timer source file. Implemented by user/ customer to initialize the timer.
10	Timer.h	Timer definition header file. Declare standards APIs.
11	wrp_user_uart.c	UART wrapper source file. Implemented by user/ customer to access the hardware driver of all channels.
12	wrp_user_uart.h	UART wrapper header file.

### 3. Basic operation

The basic operation for DLMS physical layer is described as follow.

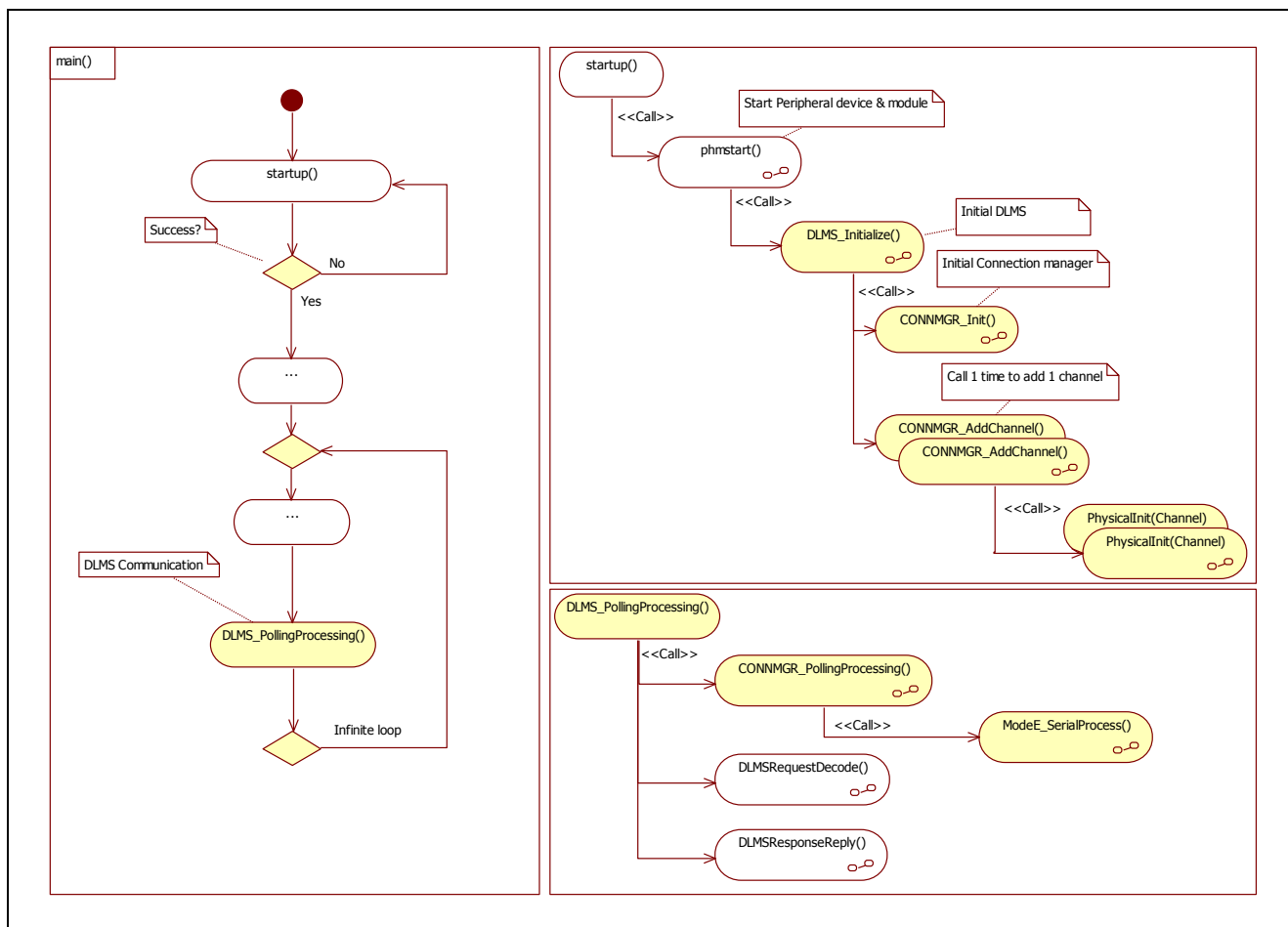


Figure 4 Physical Layer basic operation

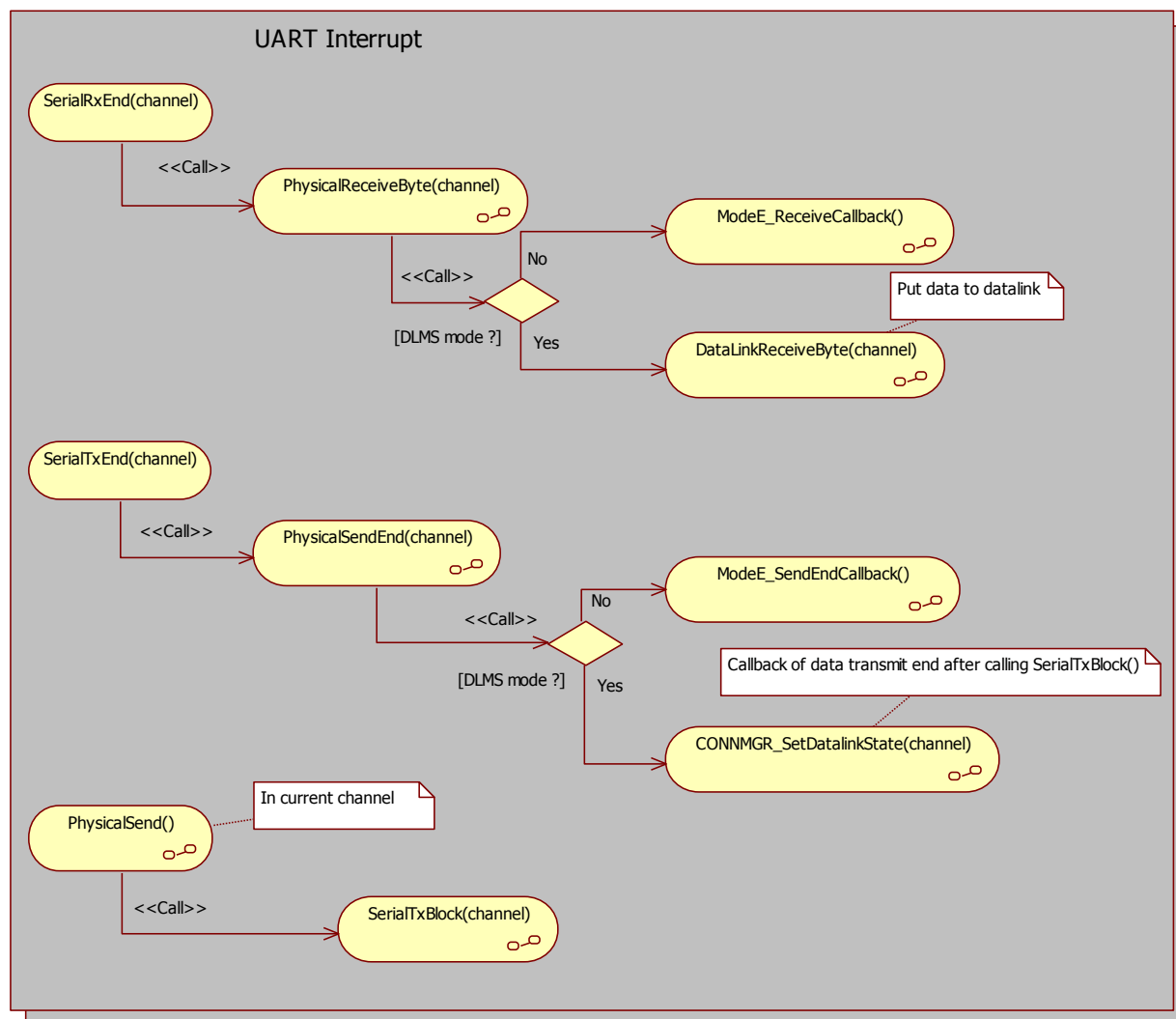


Figure 5 Physical Layer basic interrupt operation

## 4. Detail Implementation

### 4.1 Macro definitions

Below macros define the supported configuration in the current implementation. They are in  
\\application\\dlms\\DLMS\_User.h.

**Table 2 Common macros**

No.	Macro name	Value	Description
1	ModeE_ENABLE	1	Using mode E for channel
2	ModeE_DISABLE	0	Not using mode E for channel



## 4.2 Type definition

### 4.2.1 Primary type

Some common types for number as following:

**Table 3 Common number's type**

No.	Type name	GSCE Type	Definition	Size (bytes)	Description
1	Integer8	int8_t	signed char	1	Signed 1-byte character, -128...127
2	Integer16	int16_t	signed int	2	Signed 2-bytes integer, -32768...32767
3	Integer32	int32_t	signed long	4	Signed 4-bytes integer, -2147483648... 2147483647
5	Unsigned8	uint8_t	unsigned char	1	Unsigned 1-byte character, 0...255
6	Unsigned16	uint16_t	unsigned int	2	Unsigned 2-bytes integer, 0...65535
7	Unsigned32	uint32_t	unsigned long	4	Unsigned 4-bytes integer, 0...4294967295
9	Float32	float32_t	float	4	IEEE 754 Floating point format, single-precision

## 4.2.2 Physical configuration formats

### 4.2.2.1 et\_PHY\_PROTOCOL type

This is an enumeration type.

**Table 4 et\_PHY\_PROTOCOL type**

No.	Unit name	Value	Description
1	IEC_PROTOCOL	0	IEC protocol
2	HDLC_PROTOCOL	1	HDLC protocol
3	PROTOCOL_NOT_SPECIFIED	0xFF	Protocol is not specified

### 4.2.2.2 et\_BAUD\_RATE type

This is an enumeration type.

**Table 5 et\_BAUD\_RATE type**

No.	Unit name	Value	Description
1	BAUD_RATE_300	'0'	
2	BAUD_RATE_600	'1'	
3	BAUD_RATE_1200	'2'	
4	BAUD_RATE_2400	'3'	
5	BAUD_RATE_4800	'4'	
6	BAUD_RATE_9600	'5'	
7	BAUD_RATE_19200	'6'	
8	BAUD_RATE_NOT_SPECIFIED	0xFF	

**4.2.2.3 st\_ServerConfig type**

This is a structure type, little-endian. Total size is 5 bytes.

**Table 6 st\_ServerConfig type**

No.	Type name (Element)	Type	Description
1	SerialInit_FuncPtr	fn_SerialInit	Function pointer
2	SerialConfig_FuncPtr	fn_SerialConfig	Function pointer
3	SerialTx_FuncPtr	fn_SerialTx	Function pointer
4	*Server_Buffer	Unsigned8	
5	Server_BufferSize	Unsigned16	
6	AdressByteMode	Unsigned8	
7	*ServerPhysicalAddress	Unsigned8	
8	*DeviceAddress	Unsigned8	
9	*ManufacturerID	Unsigned8	
10	*ID	Unsigned8	
11	IEC_BaudRate	Unsigned8	
12	HDLC_BaudRate	Unsigned8	
13	Response_Timeout	Unsigned16	
14	Inactivity_Timeout	Unsigned16	
15	Interframe_Timeout	Unsigned16	

### 4.3 Function reference

Below functions are supported APIs for establish and configure channels in DLMS physical layer.

#### 4.3.1 DLMSInit

<b>Synopsis</b>	DLMS Init
<b>Prototype</b>	<pre>Integer8 DLMSInit (     st_ServerConfig ServerConfig );</pre>
<b>Description</b>	DLMS Init
<b>Return value</b>	Integer8
<b>Program example</b>	<p>For more on the usage, please refer to [application\dlms\DLMS_User.c] file.</p> <pre>#include "DLMS_User.h"  void DLMS_Initialize(void) {     ...      /* Initialize the stack library */     DLMSInit(UserServerConfig);      ... }</pre>

#### 4.3.2 CONNMGR\_ChannelCount

<b>Synopsis</b>	Get registered channel number
<b>Prototype</b>	<pre>Unsigned8 CONNMGR_ChannelCount(void);</pre>
<b>Description</b>	<p>Get registered channel number</p> <p>At least 0, maximum is the returned value of CONNMGR_MaxChannelNumber()</p>
<b>Return value</b>	<p>Unsigned8</p> <p>Number of registered channels</p>
<b>Program example</b>	<pre>#include "DLMS_User.h"  Unsigned8 channel_nr = CONNMGR_ChannelCount();</pre>

#### 4.3.3 CONNMGR\_MaxChannelNumber

<b>Synopsis</b>	Get max supported channel number
<b>Prototype</b>	<pre>Unsigned8 CONNMGR_MaxChannelNumber (void);</pre>
<b>Description</b>	Get max supported channel number
<b>Return value</b>	<p>Unsigned8</p> <p>Number of supported channels</p>

**Program example**

```
#include "DLMS_User.h"

Unsigned8 max_channel_nr = MAX_CONNMGR_CHANNEL_NUMBER();
```

## 4.3.4 CONNMGR\_GetCurrentChannelID

<b>Synopsis</b>	Get current channel ID
<b>Prototype</b>	<code>Unsigned8 CONNMGR_GetCurrentChannelID (void);</code>
<b>Description</b>	Get current channel ID, assigned by CONNMGR_AddChannel()
<b>Return value</b>	Unsigned8 Channel ID of current channel
<b>Program example</b>	<pre>#include "DLMS_User.h"  Unsigned8 channel_id = CONNMGR_GetCurrentChannelID();</pre>

## 4.3.5 CONNMGR\_AddChannel

<b>Synopsis</b>	Add 1 more channel for connection manager
<b>Prototype</b>	<pre>Unsigned8 CONNMGR_AddChannel (     Unsigned8    channel_id,          /* Channel ID */     Unsigned8    modeE_enable,       /* Mode E support */     Unsigned8    *Tx_Buffer,         /* Tx buffer start */     Unsigned16   Tx_Buffer_Size,     /* Tx buffer size */     Unsigned8    *Rx_Buffer,         /* Rx buffer start */     Unsigned16   Rx_Buffer_Size      /* Rx buffer size */ );</pre>
<b>Description</b>	<p>Add 1 more channel for connection manager</p> <p>This function should be called after DLMSInit() calling</p>
<b>Return value</b>	Unsigned8 1: success, 0: fail
<b>Program example</b>	For more on the usage, please refer to [application\dlms\DLMS_User.c] file.

## 4.3.6 PhysicalTimeoutCount

<b>Synopsis</b>	Physical time out callback
<b>Prototype</b>	<code>Unsigned8 CONNMGR_ChannelCount(void);</code>
<b>Description</b>	Physical 1ms time out callback
<b>Return value</b>	None
<b>Program example</b>	<p>Append this API to timer driver (i.e: In driver\mcu\r_timer_user.c)</p> <pre>#include "DLMS_User.h"  __interrupt void R_TAU0_Channel4_Interrupt(void) {     /* Start user code. Do not edit comment generated here */     EI();      PhysicalTimeoutCount();     /* End user code. Do not edit comment generated here */ }</pre>

## 4.3.7 PhysicalReceiveCallback

<b>Synopsis</b>	Callback when receive 1 byte
<b>Prototype</b>	<pre>void PhysicalReceiveCallback (     Unsigned8 channel_id,     Unsigned8 byte, );</pre>
<b>Description</b>	Callback when receive 1 byte
<b>Return value</b>	None
<b>Program example</b>	<p>For more on the usage, please refer to [application\dlms\physical\serial.c] file.</p> <pre>#include "DLMS_User.h"  void SerialRxEnd(Unsigned8 channel, Unsigned8 byte) {     /* Put data to physical layer */     PhysicalReceiveCallback(channel, byte); }</pre>

## 4.3.8 PhysicalSendEndCallback

<b>Synopsis</b>	Send End callback
<b>Prototype</b>	<pre>void PhysicalSendEndCallback (     Unsigned8 channel_id, );</pre>
<b>Description</b>	Callback of Send End
<b>Return value</b>	None

**Program example**

For more on the usage, please refer to [application\dlms\physical\serial.c] file.

```
#include "DLMS_User.h"

void SerialTxEnd ()
{
    /* Notify to physical layer */
    PhysicalSendEndCallback(channel);
}
```

**4.3.9 InitSerial****Synopsis**

Initialization of serial

**Prototype**

```
void InitSerial (
    Unsigned8 channel_id,
);
```

**Description**

Initialization of UART unit to enable serial receive/transmit operations

**Return value**

None

**Program example**

For more on the usage, please refer to [application\dlms\DLMS\_User.c] file.

**4.3.10 SerialTxEnd****Synopsis**

Physical layer's callback of data transmit end through serial communication

**Prototype**

```
void SerialTxEnd (
    Unsigned8 channel_id,
);
```

**Description**

Callback of data transmit end

**Return value**

None

**Program example**

Append this API to wrapper of UART driver (In \wrapper\user\wrp\_user\_uart.c)

```
#include "serial.h"

void WRP_UART0_SendEndCallback ()
{
    /* DLMS Transmit End */
    SerialTxEnd(CHANNEL_PRIMARY);
}
```

**4.3.11 SerialRxEnd****Synopsis**

Physical layer's callback of data receive end through serial communication

**Prototype**

```
void SerialRxEnd (
    Unsigned8 channel_id,
    Unsigned8 byte,
);
```

**Description**

Callback of data Receive end

**Return value**

None



**Program example**

Append this API to wrapper of UART driver (In \wrapper\user\wrp\_user\_uart.c)

```
#include "serial.h"

void WRP_UART0_ReceiveEndCallback()
{
    /* DLMS Transmit End */
    SerialRxEnd(CHANNEL_PRIMARY, g_received_byte);

    /* Register to received next byte */
    WRP_UART0_ReceiveData(&g_received_byte, 1);
}
```

## 4.3.12 SerialTxBlock

<b>Synopsis</b>	Transmit block of data through serial communication
<b>Prototype</b>	<pre>void SerialTxBlock (     Unsigned8 channel_id,     Unsigned8 *BlockPtr    // [Input] Pointer to block start address     Integer16 Length       // [Input] Length of the data in byte );</pre>
<b>Description</b>	Start serial transmit of block, complete until SerialTxEnd() callback is called
<b>Return value</b>	None
<b>Program example</b>	<p>Implement this API to connect to UART driver (In \application\dlms\physical\serial.c)</p> <pre>void SerialTxBlock(Unsigned8 channel, Unsigned8* BlockPtr, Integer16 Length) {     /* Start serial transmit */     switch (channel)     {         case CHANNEL_PRIMARY:             WRP_UART0_SendData(BlockPtr, Length);             break;         case CHANNEL_SECONDARY:             WRP_UART1_SendData(BlockPtr, Length);             break;         default:             /* Do nothing */             break;     } }</pre>

## 4.3.13 SerialConfig

<b>Synopsis</b>	Reconfigure UART to adapt with new baud_rate,new protocol
<b>Prototype</b>	<pre>void SerialTxBlock (     Unsigned8 channel_id,     Unsigned8 new_baud_rate     Unsigned8 new_protocol );</pre>
<b>Description</b>	Reconfigure UART to adapt with new baud_rate,new protocol
<b>Return value</b>	None

**Program example**

Implement this API to connect to UART driver (In \application\dlms\physical\serial.c)

```
void SerialConfig(unsigned channel, unsigned new_baud_rate, unsigned
new_protocol)
{
    /* Set Baud rate of UART channel */
    if(new_baud_rate != BAUD_RATE_NOT_SPECIFIED)
    {
        switch (channel)
        {
            case CHANNEL_PRIMARY:
                WRP_UART0_ChangeBaudRate(new_baud_rate);
                break;
            case CHANNEL_SECONDARY:
                WRP_UART1_ChangeBaudRate(new_baud_rate);
                break;
            default:
                /* Do nothing */
                break;
        }
    }

    /* Reconfigure UART to adapt with new protocol */
    if(new_protocol == IEC_PROTOCOL)
    {
        switch (channel)
        {
            case CHANNEL_PRIMARY:
                WRP_UART0_ConfigIECProtocol();
                break;
            case CHANNEL_SECONDARY:
                WRP_UART1_ConfigIECProtocol();
                break;
            default:
                /* Do nothing */
                break;
        }
    }
    else if(new_protocol == HDLC_PROTOCOL)
    {
        switch (channel)
        {
            case CHANNEL_PRIMARY:
                WRP_UART0_ConfigHDLCProtocol();
                break;
            case CHANNEL_SECONDARY:
                WRP_UART1_ConfigHDLCProtocol();
                break;
            default:
                /* Do nothing */
                break;
        }
    }
    else
    {
        /* Do nothing */
    }
}
```

**4.3.14 TimerRCinit****Synopsis**

Initialises RC timer

**Prototype**

**unsigned** TimerRCinit (**void**);

**Description**

Initialises RC timer

**Return value**

None

**Program example**

Implement this API to connect to Tlmer driver (In \application\dlms\physical\Timer.c)

```
#include "Timer.h"

void TimerRCinit(void)
{
    R_TAU0_Channel4_Start();
}
```

## 5. Sample workspace

### 5.1 List of change files

For physical layer porting and customize, list of changed file is described as below:

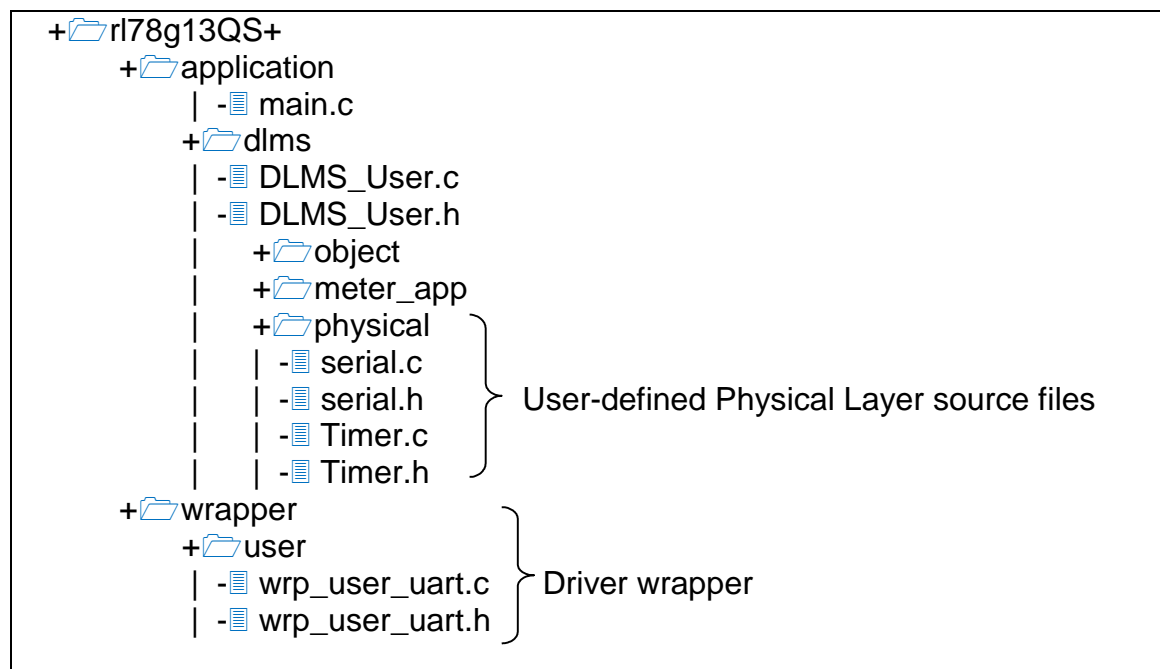


Figure 6 List of changed files

### 5.2 Register API callbacks in driver

For driver adaptation, below is list of API callbacks customized by User.

Table 7 List of API callbacks customized by User

No.	Function name	Description
1	PhysicalTimeoutCount	1ms timer callback
2	SerialRxEnd	Call PhysicalSendEndCallback
3	SerialTxEnd	Call PhysicalReceiveCallback

### 5.3 Configure DLMS physical parameters

To configure DLMS physical layer by DLMSInit() function, below files is related to:

**Table 8 Related file for new object definition**

No.	File name	Description
1	DLMS_User.h	Reference header file. All related structure definition for DLMS physical layer.
2	DLMS_User.c	Configure DLMS parametrs.

For example:

```

Unsigned8      RxBufferMain[MAX_RECIEVE_BUFFER_SIZE];
Unsigned8      RxBufferSub[MAX_RECIEVE_BUFFER_SIZE];
Unsigned8      TxBuffer[MAX_TRANSMIT_BUFFER_SIZE];
Unsigned8      ServerBuffer[MAX_SERVER_BUFFER_SIZE];

const Unsigned8      ServerPhysicalAddress[] = {0x03, 0x23, 0x00, 0x23};
const Unsigned8      DeviceAddress[] = "RES001";           /* max 32 character */
const Unsigned8      ManufacturerID[] = "REN";            /* 3 character */
const Unsigned8      ID[] = "SPEM";                      /* max 16 character */

/* Config parameter for DLMS library here */
const st_ServerConfig UserServerConfig =
{
    InitSerial,           /* SerialInit_FuncPtr */
    SerialConfig,         /* SerialConfig_FuncPtr */
    SerialTxBlock,        /* SerialTx_FuncPtr */
    ServerBuffer,         /* *Server_Buffer */
    MAX_SERVER_BUFFER_SIZE, /* Server_BufferSize */
    PHYADD_1BYTE_SUPPORTED, /* AdressByteMode */
    ServerPhysicalAddress, /* *ServerPhysicalAddress */
    DeviceAddress,        /* *DeviceAddress */
    ManufacturerID,       /* *ManufacturerID */
    ID,                   /* *ID */
    BAUD_RATE_300,        /* IEC_BaudRate */
    BAUD_RATE_9600,       /* HDLC_BaudRate */
    5000,                 /* Response_Timeout */
    5000,                 /* Inactivity_Timeout */
    100,                  /* Interframe_Timeout */
};

```

```
void DLMS_Initialize(void)
{
    TimerRCinit();

    /* Initialize the stack library */
    DLMSInit(UserServerConfig);
    ...
}
```

## 5.4 Append new channel

Appending 1 or more channels to physical layer is possible. Below is step-to-step guide line to append 3<sup>rd</sup> channel to DLMS physical layer.

### 5.4.1 Change max supported channel number

In \rl78g13QS+\application\dlms\DLMS\_User.h, change the max supported channel to 3 channels:

For example:

```
#define MAX_CONNMGR_CHANNEL_NUMBER          (3)
```

### 5.4.2 Specify channel ID

In \rl78g13QS+\application\dlms\DLMS\_User.h, specify the ID for new channel, make sure it has not same value with other channel ID or equal to 0xFF (CHANNEL\_NOT\_SPECIFIED):

For example: we define CHANNEL\_NEW as channel ID for new channel

```
/* ID of physical channel(s) */
#define CHANNEL_PRIMARY          (0x00)
#define CHANNEL_SECONDARY       (0x01)
#define CHANNEL_NEW              (0x02)
```

### 5.4.3 Link driver APIs of new channel to physical layer

In \rl78g13QS+\application\dlms\physical\serial.c, append driver API of new channel to below function to link new channel's driver with physical layer.

**Table 9 List of driver API customized by User**

No.	Function name	Description
1	InitSerial	Initialize for driver
2	SerialRxEnd	Receive end callback
3	SerialTxEnd	Transmit end callback
4	SerialTxBlock	Transmit function
5	SerialConfig	Configuration function

For example:

```
void SerialTxBlock()
{
    switch (channel)
    {
        case CHANNEL_PRIMARY:
            WRP_UART0_SendData(BlockPtr, Length);
            break;
        case CHANNEL_SECONDARY:
            WRP_UART1_SendData(BlockPtr, Length);
            break;
        case CHANNEL_NEW:
            WRP_UART2_SendData(BlockPtr, Length);
            break;
        default:
            /* Do nothing */
            break;
    }
}
```

#### 5.4.4 Add new channel to connection manager

CONNMGR\_AddChannel () is supporting API used to add new channel for connection manager and must be called after calling DLMSInit().

The number of registered channels can checked by using CONNMGR\_ChannelCount(), and maximum registered channels is the returned value of CONNMGR\_MaxChannelNumber().

For example: Add 3<sup>rd</sup> channel for connection manager in DLMS\_User.c:

```
void DLMS_Initialize(void)
{
    TimerRCinit();

    /* Initialize the stack library */
    DLMSInit(UserServerConfig);

    /* Add 1st channel */
    CONNMGR_AddChannel(
        CHANNEL_PRIMARY,          /* Channel ID */
        ModeE_ENABLE,            /* Mode E support */
        TxBuffer,                /* Tx buffer start */
        MAX_TRANSMIT_BUFFER_SIZE, /* Tx buffer size */
        RxBufferMain,            /* Rx buffer start */
        MAX_RECIEVE_BUFFER_SIZE,  /* Rx buffer size */
    );

    if (CONNMGR_MaxChannelNumber() >= 2)
    {
        /* Add 2nd channel */
        CONNMGR_AddChannel(
            CHANNEL_SECONDARY,    /* Channel ID */
            ModeE_ENABLE,        /* Mode E support */
            TxBuffer,            /* Tx buffer start */
            MAX_TRANSMIT_BUFFER_SIZE, /* Tx buffer size */
        );
    }
}
```



```
        RxBufferSub,                                /* Rx buffer start */
        MAX_RECIEVE_BUFFER_SIZE                     /* Rx buffer size  */
    );
}
if (CONNMGR_MaxChannelNumber() >= 3)
{
    /* Add 3rd channel */
    CONNMGR_AddChannel(
        CHANNEL_NEW,                                /* Channel ID      */
        ModeE_ENABLE,                               /* Mode E support  */
        TxBuffer,                                    /* Tx buffer start */
        MAX_TRANSMIT_BUFFER_SIZE,                   /* Tx buffer size  */
        RxBufferSub3,                                /* Rx buffer start */
        MAX_RECIEVE_BUFFER_SIZE                     /* Rx buffer size  */
    );
}
...
```

## Website and Support

Renesas Electronics Website

<http://www.renesas.com/>

Inquiries

<http://www.renesas.com/inquiry>

All trademarks and registered trademarks are the property of their respective owners.

**Revision Record**

Rev.	Date	Description	
		Page	Summary
1.00	December.12.13	All	First edition issued

## General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

### 1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

### 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

### 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

### 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable.

When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

### 5. Differences between Products

Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.

The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

## Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
3. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics product.
5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.  
"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.  
"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; and safety equipment etc.  
Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (nuclear reactor control systems, military equipment etc.). You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application for which it is not intended. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas Electronics.
6. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
7. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or systems manufactured by you.
8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
9. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You should not use Renesas Electronics products or technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. When exporting the Renesas Electronics products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
10. It is the responsibility of the buyer or distributor of Renesas Electronics products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the contents and conditions set forth in this document, Renesas Electronics assumes no responsibility for any losses incurred by you or third parties as a result of unauthorized use of Renesas Electronics products.
11. This document may not be reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.



### SALES OFFICES

### Renesas Electronics Corporation

<http://www.renesas.com>

Refer to "<http://www.renesas.com/>" for the latest and detailed information.

**Renesas Electronics America Inc.**  
2880 Scott Boulevard Santa Clara, CA 95050-2554, U.S.A.  
Tel: +1-408-588-6000, Fax: +1-408-588-6130

**Renesas Electronics Canada Limited**  
1101 Nicholson Road, Newmarket, Ontario L3Y 9C3, Canada  
Tel: +1-905-898-5441, Fax: +1-905-898-3220

**Renesas Electronics Europe Limited**  
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.  
Tel: +44-1628-651-700, Fax: +44-1628-651-804

**Renesas Electronics Europe GmbH**  
Arcadiastrasse 10, 40472 Düsseldorf, Germany  
Tel: +49-211-65030, Fax: +49-211-6503-1327

**Renesas Electronics (China) Co., Ltd.**  
7th Floor, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100083, P.R.China  
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

**Renesas Electronics (Shanghai) Co., Ltd.**  
Unit 204, 205, AZIA Center, No.1233 Lujiazui Ring Rd., Pudong District, Shanghai 200120, China  
Tel: +86-21-5877-1818, Fax: +86-21-6887-7858 /-7898

**Renesas Electronics Hong Kong Limited**  
Unit 1601-1613, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong  
Tel: +852-2886-9318, Fax: +852 2886-9022/9044

**Renesas Electronics Taiwan Co., Ltd.**  
13F, No. 363, Fu Shing North Road, Taipei, Taiwan  
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

**Renesas Electronics Singapore Pte. Ltd.**  
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre Singapore 339949  
Tel: +65-6213-0200, Fax: +65-6213-0300

**Renesas Electronics Malaysia Sdn.Bhd.**  
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia  
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

**Renesas Electronics Korea Co., Ltd.**  
11F., Samik Lavied' or Bldg., 720-2 Yeoksam-Dong, Kangnam-Ku, Seoul 135-080, Korea  
Tel: +82-2-558-3737, Fax: +82-2-558-5141